CLAIMS

What is claimed is:

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ĺ	1.	A circuit for setting a substrate voltage level comprising:				
2	•	a. means for maintaining a substrate at a first predetermined voltage level;				
3		b. means for maintaining the substrate at a second predetermined voltage level,				
4		wherein the second predetermined voltage level is higher than the first				
5		predetermined voltage level;				
6		c. means for maintaining the substrate at a third predetermined voltage level,				
7		wherein the third predetermined voltage level is lower than the first				
8		predetermined voltage level.				
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u E	2.	The circuit according to claim 1 further comprising means for selecting between the				
2. 2.		first predetermined level, the second predetermined level and the third predetermined level.				
	3.	The circuit according to claim of further comprising:				
11) 2		a. means for maintaining the substrate at a fourth predetermined voltage level,				
<u>5</u>		wherein the fourth predetermined voltage level is higher than the second				
ij #		predetermined voltage level; and				
5		b. means for maintaining the substrate at a fifth predetermined voltage level,				
6		wherein the fifth predetermined voltage level is lower than the third				
7		predetermined voltage level.				
1	4.	The circuit according to claim 3 further comprising means for selecting between the				
2	first	irst predetermined level, the second predetermined level, the third predetermined level, the				
3	four	fourth predetermined level and the fifth predetermined level				

1	5.	A circuit for setting a substrate voltage level comprising:			
2	\	a. a plurality of resistive elements coupled to each other in a series to form a			
3		chain of resistive elements, the chain having a first terminal and a second			
4		terminal;			
5		b. a reference voltage source coupled to the first terminal;			
6		c. a substrate coupled to the second terminal; and			
7		d. a plurality of switches wherein each switch is coupled to bypass at least one of			
8		the resistive elements.			
1	6.	The circuit according to claim 5 wherein the resistive elements each have non-linear			
2	resista	sistances.			
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Ë	7.	The circuit according to claim 5 wherein the resistive elements comprise diodes.			
	8.	The circuit according to claim 5 wherein the resistive elements comprise MOSFETs.			
T	9.	The circuit according to claim 5 wherein the switches comprise MOSFETs.			
	· ·				
i L	10.	The circuit according to claim 5 further comprising a charge pump coupled to control			
2	the s	he substrate voltage level.			
1	11.	A circuit for setting a substrate voltage level comprising:			
2		a. a first n-channel MOSFET having a first gate, a first drain and a first source			
3		wherein the first gate is coupled to the first drain and the first gate is coupled			
4		to a voltage reference level;			

5	'	\ b.	a second n-channel MOSFET having a second gate, a second drain and a		
6			second source wherein the second gate is coupled to the second drain and the		
7			second gate is coupled to the first source;		
8		c.	a third n-channel MOSFET having a third gate, a third drain and a third source		
9			wherein the third gate is coupled to the third drain and the third gate is coupled		
.0			to the second source;		
1		d.	a forth n-channel MOSFET having a forth gate, a forth drain and a forth source		
2			wherein the forth gate is coupled to be controlled by a first control voltage and		
13			the forth drain is coupled to the third drain and the forth source is coupled to		
4			the third source;		
15 📮		e.	a fifth n-channel MOSFET having a fifth gate, a fifth drain and a fifth source		
ا آھا 6			wherein the fifth gate is coupled to the third gate and the fifth drain is coupled		
17 E			to the third source and the fifth source is coupled to a substrate; and		
16 J		f.	a sixth n-channel MOSFET having a sixth gate, a sixth drain and a sixth source		
19. Ē			wherein the sixth drain is coupled to the fifth drain and the sixth source is		
20 🗇			coupled to the fifth source and the sixth gate is coupled to be controlled by a		
21			second control voltage.		
1 ≠	12.	The c	ircuit according to claim 11 further comprising a charge pump having a input		
2	terminal and an output terminal, wherein the input terminal is coupled to the first source and				
3	the output terminal is coupled to the substrate.				
1	13.	The c	circuit according to claim 11 further comprising:		
2		a.	a seventh n-channel MOSFET having a seventh gate, a seventh drain and a		
3			seventh source wherein the seventh gate is coupled to the fifth gate, the seventh		
4			drain is coupled to the fifth source and the seventh source is coupled to the		
5			substrate; and		

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b.	an eighth n-channel MOSFET having an eighth gate, an eighth drain and an
	eighth source, wherein the eighth gate is coupled to be controlled by a third
	control voltage level, the eighth drain is coupled to the seventh drain and the
	eighth source is coupled to the seventh source.

- 14. The circuit according to claim 13 further comprising a charge pump having a input terminal and an output terminal, wherein the input terminal is coupled to the first source and the output terminal is coupled to the substrate.
- 15. The circuit according to claim 13 further comprising:
 - a. a ninth n-channel MOSFET having a ninth gate, a ninth drain and a ninth source wherein the ninth gate is coupled to the seventh gate, the ninth drain is coupled to the seventh source and the ninth source is coupled to the substrate; and
 - b. a tenth n-channel MOSFET having a tenth gate, a tenth drain and a tenth source, wherein the tenth gate is coupled to be controlled by a forth control voltage level, the tenth drain is coupled to the ninth drain and the tenth source is coupled to the ninth source.
- 16. The circuit according to claim 15 further comprising a charge pump having a input terminal and an output terminal, wherein the input terminal is coupled to the first source and the output terminal is coupled to the substrate.
- 17. A method of testing integrated circuit chips comprising the steps of:
 - a. setting a voltage level of a substrate to a first predetermined level; and

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3		B:	setting the voltage leve	el of the substrate to a second predetermined level
4		`	wherein the second pre	edetermined level is higher than the first predetermined
5			level.	•
1	18.	A m	ethod of testing integrated	reircuit chips comprising the steps of:
2		a.		of a substrate to a first predetermined level; and
3		b.	_	el of the substrate to a second predetermined level
4			-	edetermined level is lower than the first predetermined
5			level.	
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